# **LNJ306G5TR02**

### Surface Mounting Chip LED

S-GW Type

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	60	mW	
Forward current	$I_{\mathrm{F}}$	20	mA	
Pulse forward current *	$I_{FP}$	60	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	Topr	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

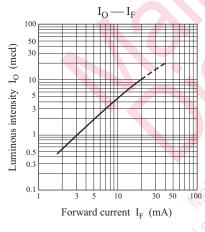
Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

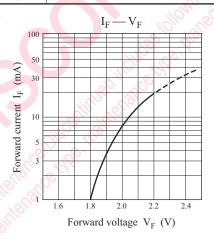
### ■ Lighting Color

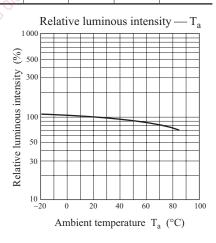
• Yellow Green

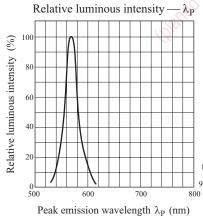
#### ■ Electro-Optical Characteristics $T_a = 25$ °C

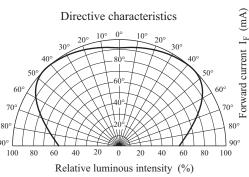
						O	
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>	$I_F = 10 \text{ mA}$		3.0	5.0	30	mcd
Reverse current	I <sub>R</sub>	$V_R = 4 V$		(10t)	7160,	10	μΑ
Forward voltage	$V_{\rm F}$	$I_F = 10 \text{ mA}$		100,100	2.03	2.6	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	ion,	dillo	565		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	Peir Oni	<i>b</i> ,	30		nm

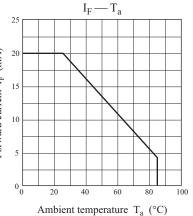








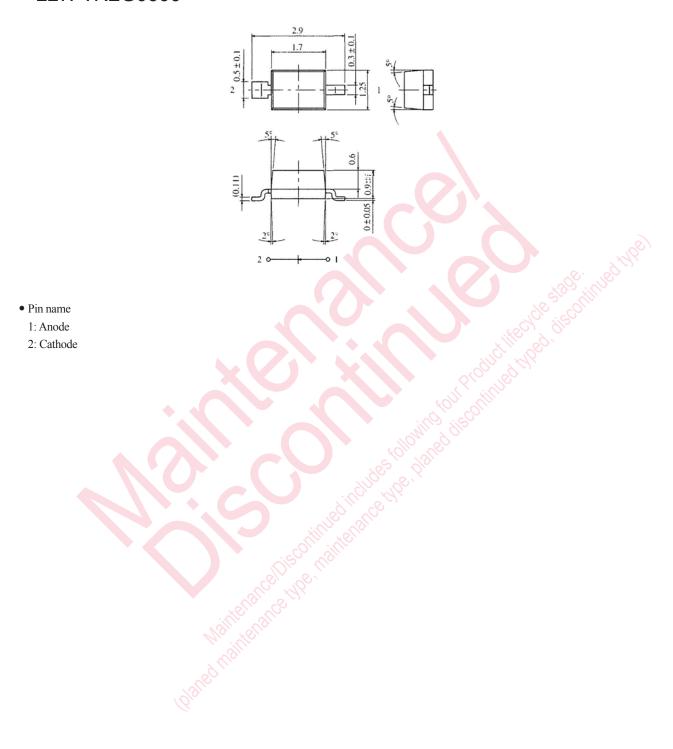




LNJ306G5TR02 Panasonic

■ Package (Unit: mm)

## LLTFTN2G0600



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